



PATENT
2019-0202P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: YANG, Chih-An et al. Conf.: 4144
Appl. No.: 10/611,875 Group: 2815
Filed: July 3, 2003 Examiner: Sheila V. Clark
For: LEADFRAME PAKAGING APPARATUS AND
PACKAGING METHOD THEREOF

REPLY UNDER 37 C.F.R. § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Monday, May 17, 2004

Sir:

Responsive to the January 16, 2004 Office Action, the due date for response having been extended one (1) month to May 16, 2004, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes:

Amendments to the Specification;

Amended Claim Set; and

Remarks.

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